WHAT IS CLAIMED IS:

- 1. An image sensor comprising:
- (a) a substrate having a plurality of photosensitive sites for capturing an image and a plurality of additional photosensitive sites adjacent the image capturing photosensitive sites in which there is no image capture; and
- (b) a digital signal embedded in one or more of the additional photosensitive sites for the purpose of identification.
- 2. The image sensor as in claim 1, wherein the digital signal identifies individually or in any combination particular manufacturer, lot, wafer, and/or position on the wafer during manufacture of the image sensor
- 3. The image sensor as in claim 1 wherein the embedded digital signal includes a watermark for electronic identification of the sensor without affecting any aspect of the image captured by the plurality of sites used to capture the image.
- 4. The image sensor as in claim 1 further comprising an electronic structure for preventing charge from passing to an amplifier for identifying the embedded digital signal.
 - 5. A method for creating an image sensor comprising the steps of:
- (a) providing a substrate having a plurality of photosensitive sites for capturing an image and a plurality of additional photosensitive sites adjacent the image capturing photosensitive sites in which there is no image capture; and
- (b) embedding a digital signal in one or more of the additional photosensitive sites for the purpose of identification.
- 6. The method as in claim 5 wherein step (b) includes etching a protective metal spanning one or more of the additional photosensitive sites in a predefined sequence.

- 7. The method as in claim 5 where the predefined sequence is repeated in a predetermined manner to provide redundancy as a safeguard for problems which might affect the ability of the photoactive site from registering a signal.
- 8. The method as in claim 5 wherein the predefined sequence is used as a watermark for electronic identification.
- 9. The method as in claim 5 further comprising providing an electronic structure for preventing charge from passing to an amplifier for identifying the embedded digital signal.
 - 10. An image capture device comprising:
 - (a) an image sensor comprising:
- (a1) a substrate having a plurality of photosensitive sites for capturing an image and a plurality of additional photosensitive sites adjacent the image capturing photosensitive sites in which there is no image capture; and
- (a2) a digital signal embedded in one or more of the additional photosensitive sites for the purpose of identification.
- 12. The image capture device as in claim 10, wherein the digital signal identifies individually or in any combination particular manufacturer, lot, wafer, and/or position on the wafer during manufacture of the image sensor
- 13. The image capture device as in claim 10, wherein the embedded digital signal includes a watermark for electronic identification of the sensor without affecting any aspect of the image captured by the plurality of sites used to capture the image.
- 14. The image capture device as in claim 10 further comprising an electronic structure for preventing charge from passing to an amplifier for identifying the embedded digital signal.